onsemi

MOSFET – Power, Single N-Channel 100 V, 26 mΩ, 28 A

NVMFS027N10MCL

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- AEC-Q101 Qualified and PPAP Capable
- NVMFWS027N10MCL Wettable Flank Products
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	100	V
Gate-to-Source Voltage			V _{GS}	±20	V
Continuous Drain	Steady	$T_C = 25^{\circ}C$	۱ _D	28	А
Current $R_{\theta JC}$ (Notes 1, 3)		T _C = 100°C		20	
Power Dissipation	State	$T_C = 25^{\circ}C$	P _D	46	W
$R_{\theta JC}$ (Note 1)		$T_{C} = 100^{\circ}C$		23	
Continuous Drain		$T_A = 25^{\circ}C$	۱ _D	7.9	А
Current R _{θJA} (Notes 1, 2, 3)	Steady	T _A = 100°C		5.6	
Power Dissipation	State	T _A = 25°C	PD	3.5	W
$R_{\theta JA}$ (Notes 1, 2)		T _A = 100°C		1.8	
Pulsed Drain Current	T _A = 25	°C, t _p = 10 μs	I _{DM}	137	А
Operating Junction and Storage Temperature Range			T _J , T _{stg}	–55 to +175	°C
Source Current (Body Diode)			I _S	35	А
Single Pulse Drain–to–Source Avalanche Energy ($I_{L(pk)} = 1.3 A$)			E _{AS}	414	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

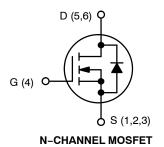
Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State (Note 1)	$R_{\theta JC}$	3.3	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	42.4	

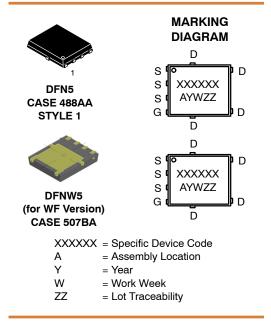
1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
100 V	26 mΩ @ 10 V	28 A
100 V	35 mΩ @ 4.5 V	20 A





ORDERING INFORMATION

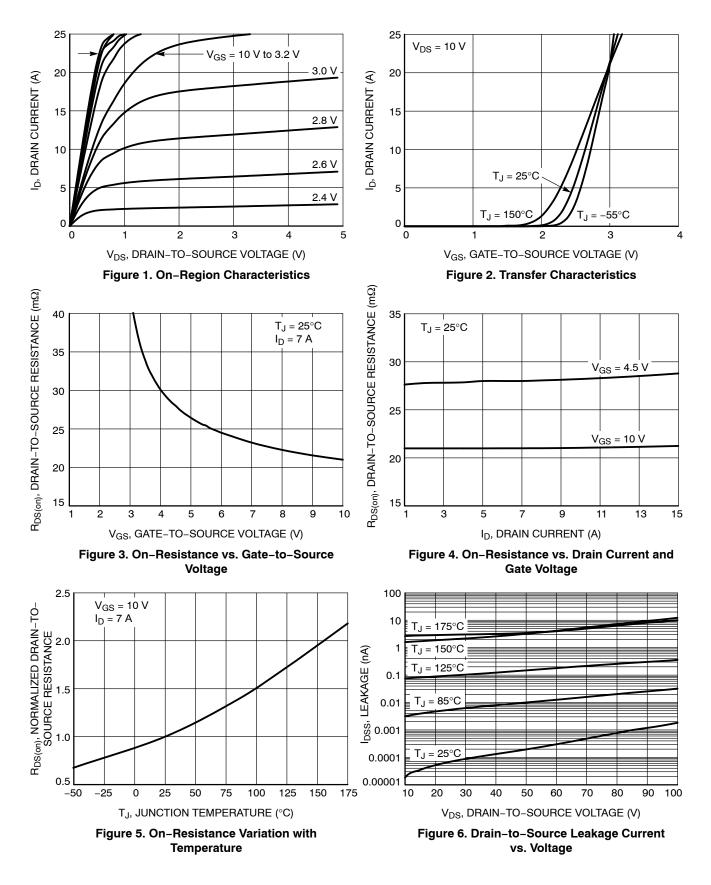
See detailed ordering, marking and shipping information on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

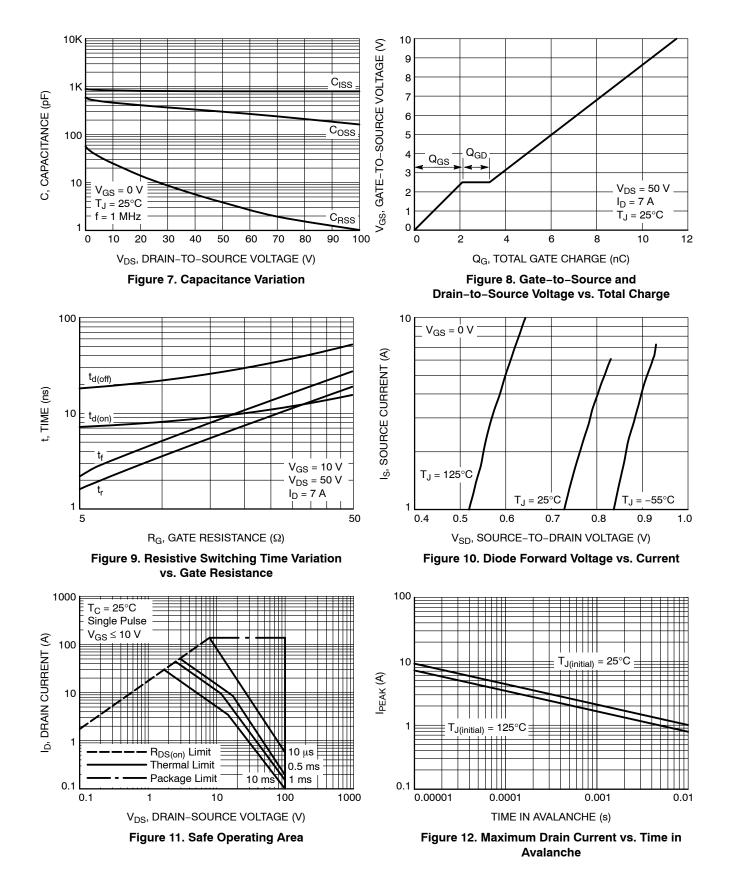
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 μ A		100			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				53		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V,$	T _J = 25 °C			1.0	μΑ
		V _{DS} = 100 V	T _J = 125°C			100	
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = 20 V				100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D =$	= 38 μA	1		3	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-6		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 7 A		21	26	┼──┤
		V _{GS} = 4.5 V	I _D = 5 A		28	35	mΩ
Forward Transconductance	9 _{FS}	V _{DS} = 10 V, I _D = 7 A			25		S
CHARGES, CAPACITANCES & GATE RESISTANCE							
Input Capacitance	C _{ISS}				800		
Output Capacitance	C _{OSS}	V_{GS} = 0 V, f = 1 MHz, V_{DS} = 50 V			300		pF
Reverse Transfer Capacitance	C _{RSS}				4		
Gate Resistance	R _G				0.41		Ω
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 4.5 V, V_{DS} = 50 V; I_D = 7 A			5.5		nC
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 10 V, V_{DS} = 50 V; I_{D} = 7 A			11.5		nC
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 10 V, V _{DS} = 50 V; I _D = 7 A			1.3		
Gate-to-Source Charge	Q _{GS}				2.1		nC
Gate-to-Drain Charge	Q _{GD}				1.2		
Plateau Voltage	V _{GP}				2.5		V
Output Charge	Q _{OSS}	V _{GS} = 0 V, V _{DS} = 50 V			87		nC
SWITCHING CHARACTERISTICS (Note 4)							
Turn-On Delay Time	t _{d(ON)}	V _{GS} = 10 V, V _{DS} = 50 V, I _D = 7 A, R _G = 6.0 Ω			7.4		
Rise Time	t _r				2		ns
Turn-Off Delay Time	t _{d(OFF)}				19		
Fall Time	t _f				2.9		
DRAIN-SOURCE DIODE CHARACTERISTI	cs						
Forward Diode Voltage	V _{SD}	$V_{SD} = V_{GS} = 0 \text{ V, } \text{ I}_{S} = 7 \text{ A, } \text{ T}_{J} = 25^{\circ}\text{C}$ $V_{GS} = 0 \text{ V, } \text{ I}_{S} = 7 \text{ A, } \text{ T}_{J} = 125^{\circ}\text{C}$			0.84	1.3	V
					0.73		
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dI _S /dt = 100 A/µs, I _S = 3 A			28		ns
Reverse Recovery Charge	Q _{RR}				17		nC
Charge Time	ta				13.9		ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



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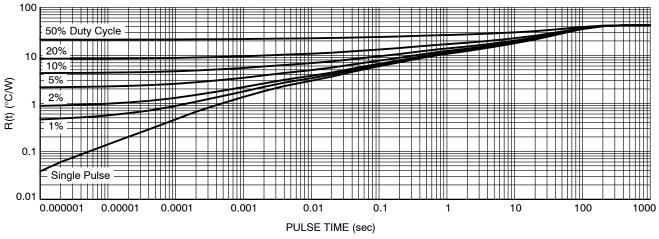


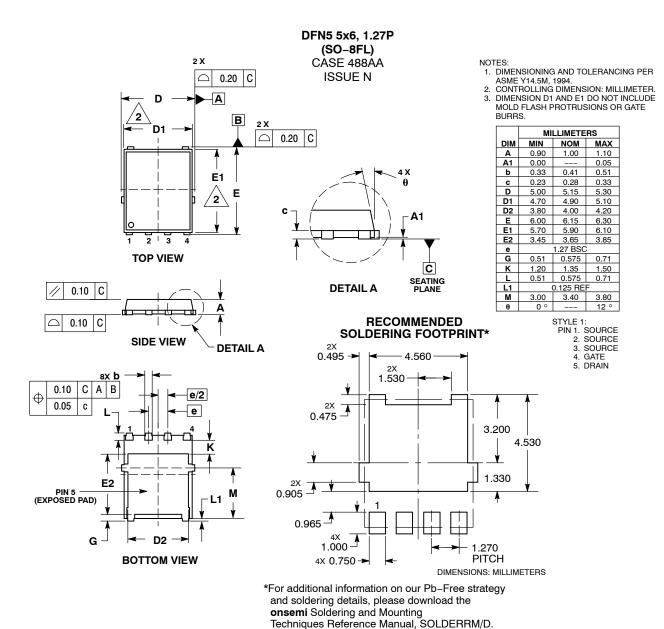
Figure 13. Thermal Response

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NVMFS027N10MCLT1G	027L10	DFN5 (Pb–Free)	1500 / Tape & Reel
NVMFWS027N10MCLT1G	027W10	DFN5 (Wettable Flank, Pb-Free)	1500 / Tape & Reel

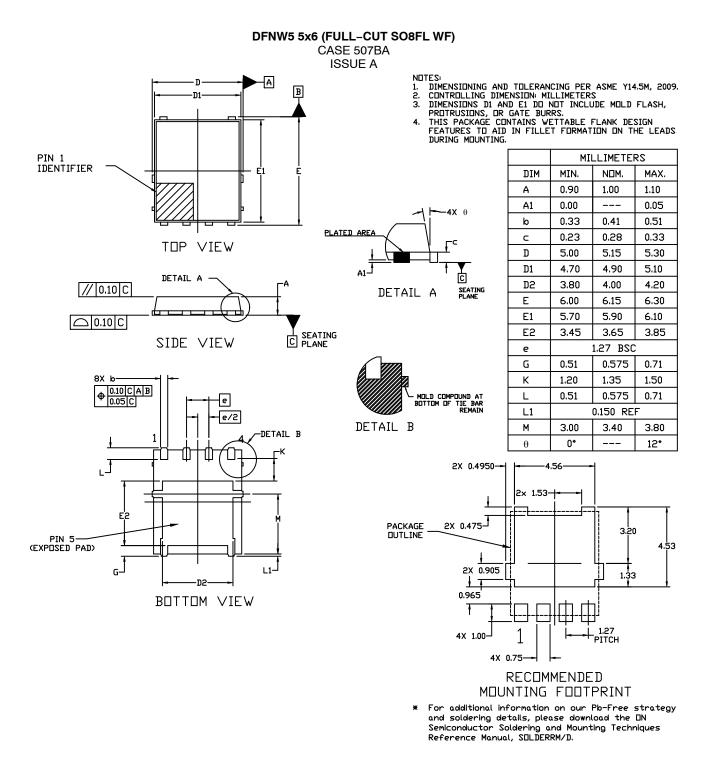
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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